

VST007P06MS-VB Datasheet P-Channel 60 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^c		
- 60	0.0074 at V _{GS} = - 10 V	- 90		
	0.0094 at V _{GS} = - 4.5 V	- 90		

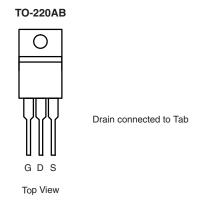
FEATURES

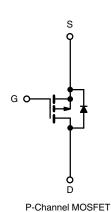
- Trench Power MOSFET
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

• DC/DC Primary Switch





ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	- 60	V			
Gate-Source Voltage	V _{GS}	± 20	V			
Continuous Drain Current /T 175 °C\C	T _C = 25 °C	L	- 90	А		
Continuous Drain Current (T _J = 175 °C) ^c	T _C = 125 °C	l _D	- 67			
Pulsed Drain Current	I _{DM}	- 200	A			
Avalanche Current	L = 0.1 mH	I _{AS}	- 65			
Single Pulse Avalanche Energy ^a	L=0.11IIII	E _{AS}	211	mJ		
Power Dissipation	T _C = 25 °C	P _D	250 ^b	- W		
rower Dissipation	T _A = 25 °C	' D	2.4			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient Free Air	R _{thJA}	62	°C/W		
Junction-to-Case	R _{thJC}	0.6	C/VV		

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. Limited by package.

服务热线:400-655-8788

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 60			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = - 60 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 125 °C			- 50	μА	
		V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 175 °C			- 250		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 120			Α	
		V _{GS} = - 10 V, I _D = - 30 A		0.0074			
Durin Orania Ora Olata Basistana a	B	V _{GS} = - 10 V, I _D = - 30 A, T _J = 125 °C		0.0150		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -10 \text{ V}, I_D = -30 \text{ A}, T_J = 175 ^{\circ}\text{C}$		0.0190			
		V _{GS} = - 4.5 V, I _D = - 20 A		0.0094		1	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 30 A	20			S	
Dynamic ^b							
Input Capacitance	C _{iss}			9200		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 25 V, f = 1 MHz		975			
Reverse Transfer Capacitance	C _{rss}			760			
Total Gate Charge ^c	Q_g			160	240	nC	
Gate-Source Charge ^c	Q_{gs}	V _{DS} = - 30 V, V _{GS} = - 10 V, I _D = - 90 A		40			
Gate-Drain Charge ^c	Q_{gd}			36		1	
Gate Resistance	R_g	f = 1.0 MHz		3		Ω	
Turn-On Delay Time ^c	t _{d(on)}			20	30		
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V}, R_{L} = 0.33 \Omega$		190	285		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 90 A, V_{GEN} = - 10 V, R_g = 2.5 Ω		140	210	ns	
Fall Time ^c	t _f			300	450	1	
Source-Drain Diode Ratings and Ch	aracteristics	(T _C = 25 °C) ^b					
Continuous Current	I _S				- 90		
Pulsed Current	I _{SM}				- 200	Α	
Forward Voltage ^a	V_{SD}	I _F = - 50 A, V _{GS} = 0 V		- 1.0	- 1.5	V	
Reverse Recovery Time	t _{rr}			60	90	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 50 A, dI/dt = 100 A/μs		- 3	- 4.5	Α	
Reverse Recovery Charge	Q _{rr}	1		0.09	0.2	μС	

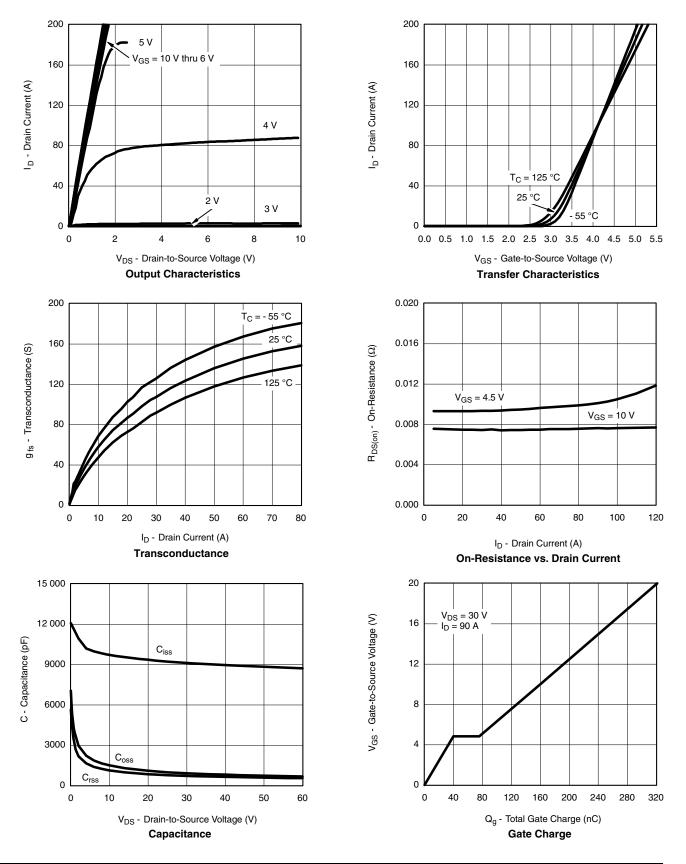
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

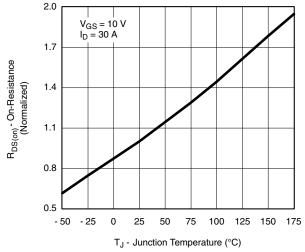


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

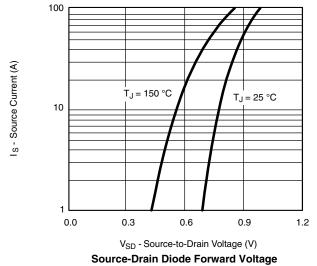


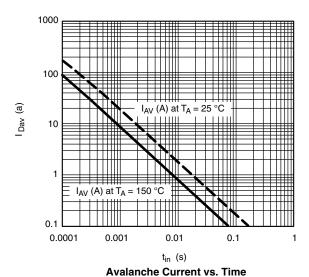


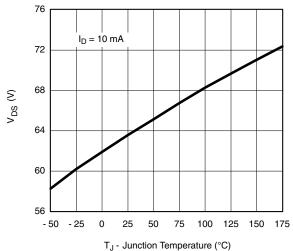
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



On-Resistance vs. Junction Temperature



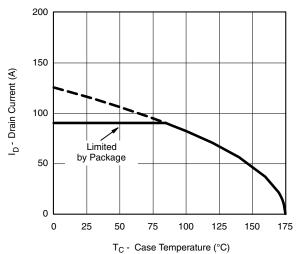




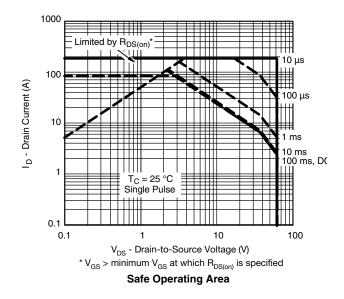
Drain Source Breakdown vs.
Junction Temperature

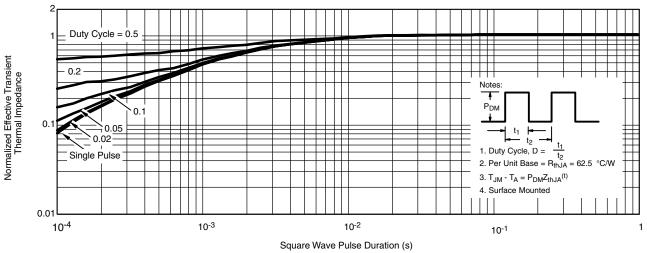


THERMAL RATINGS



Maximum Avalanche and Drain Current vs. Case Temperature

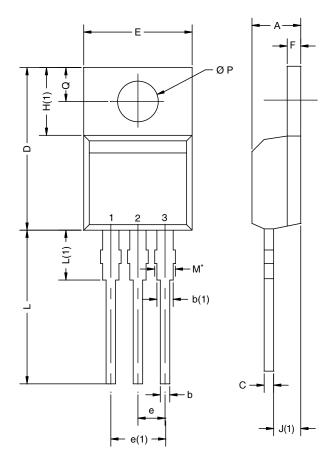


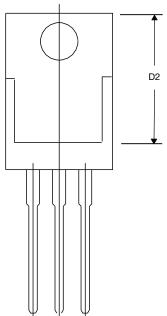


Normalized Thermal Transient Impedance, Junction-to-Case



TO-220AB





	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471					

Note

 $^{^{\}star}$ M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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